

Apex Innovative Tech Center Winners Announced

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BANNOCKBURN, IL – IPC announced products to be featured in the Innovative Technology Center for emerging interconnect technologies at the Apex trade show next month.

Among the assembly products on display will be **BEST Inc.'s** EZReball; **DEK's** Reel-to-Reel printer; **EKRA's** iPAG Integrated Paste and Glue Dispenser; **Electronic Control Design's** Megam.o.l.e. 20 thermal profiler; **Henkel's** PowerstrateXtreme Dispensable (PSX-D) thermal interface material; **Hesse & Knipps's** PiQC Process Integrated Quality Control for thin and heavy wire bonders, and **Mydata Automation's** MY500 printer.

In the area of test, **Agilent Technologies** will show its Powered Vectorless Limited Access Solution for in-circuit test; **Phoenix X-ray Systems** its s Microme x with xact, and **Seica** its Pilot V8.

In the area of PCB fabrication, **American Plating Power** will show its Reverse Pulse Plating Rectifier AxD G3, and **Printar** will show GreenJet.

The selections were made by a panel of industry experts.